

Inductors for power circuits Wound metal SPM-HZ series (for automotive)











SPM5030-HZ type













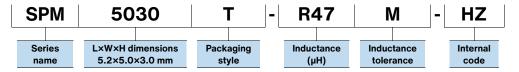
FEATURES

- Magnetic shield type wound inductor for power circuits using a metallic magnetic material.
- Ocompared to ferrite wound type inductors, it is possible to achieve large current, low Rdc, and compactness.
- Low inductance variance in high-temperature environments with good DC superimposition characteristics. ?40 to 125°C (including self-temperature rise)
- OMetallic magnetic material is used, and the structure has an integrated molded coil, so hum noise is lower than with ferrite core adhesive coils.
- Operating temperature range: -40 to +125°CC(including self-heating)
- Compliant with AEC-Q200

APPLICATION

Automotive-related equipment (Car navigation, car audio)

PART NUMBER CONSTRUCTION



CHARACTERISTICS SPECIFICATION TABLE

L		Measuring frequency	DC resistance		Rated current*		Part No.
					Isat	Itemp	
(µH)	Tolerance	(kHz)	(mΩ)max.	(mΩ)typ.	(A)typ.	(A)typ.	
0.47	±20%	100	5.39	4.9	11.0	14.0	<u>SPM5030T-R47M-HZ</u>
0.68	±20%	100	7.37	6.7	8.9	13.6	<u>SPM5030T-R68M-HZ</u>
1.0	±20%	100	11.5	10.4	8.0	10.4	SPM5030T-1R0M-HZ
1.5	±20%	100	18.5	16.8	6.8	9.2	<u>SPM5030T-1R5M-HZ</u>
2.2	±20%	100	21.3	19.3	4.8	8.5	<u>SPM5030T-2R2M-HZ</u>
3.3	±20%	100	29.5	26.8	4.3	6.5	<u>SPM5030T-3R3M-HZ</u>
4.7	±20%	100	49.5	45.0	4.0	4.7	<u>SPM5030T-4R7M-HZ</u>
5.6	±20%	100	73.9	67.1	3.6	4.5	<u>SPM5030T-5R6M-HZ</u>
6.8	±20%	100	82.0	74.5	3.4	4.2	<u>SPM5030T-6R8M-HZ</u>
10.0	±20%	100	113.1	102.8	2.6	2.9	<u>SPM5030T-100M-HZ</u>

^{*} Rated current: smaller value of either lsat or Itemp.

lsat: When based on the inductance change rate (10% below the nominal value)

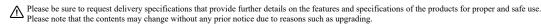
Itemp: When based on the temperature increase (temperature increase of 40°C by self heating)

Measurement equipment

Measurement item	Product No. *	Manufacturer
L	4284A	Keysight Technologies
DC resistance	AX-111A	ADEX
Rated current Isat	4284A+42841A+42842C	Keysight Technologies

^{*} Equivalent measurement equipment may be used.



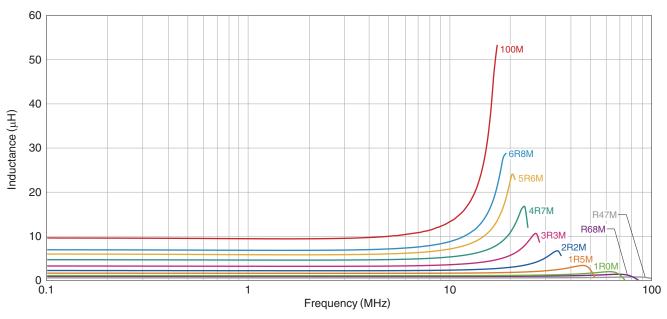






SPM5030-HZ type

L FREQUENCY CHARACTERISTICS

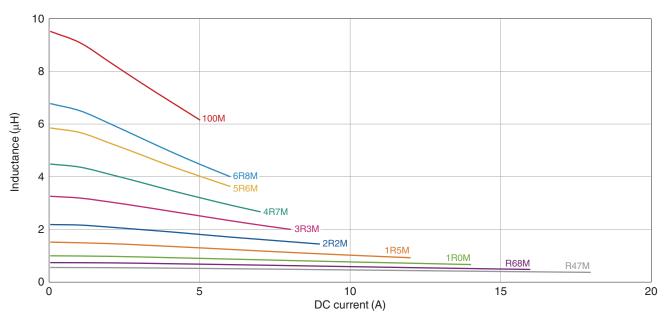


Measurement equipment

Product No. *	Manufacturer		
4294A	Keysight Technologies		

^{*} Equivalent measurement equipment may be used.

INDUCTANCE VS. DC BIAS CHARACTERISTICS



Measurement equipment

Product No. *	Manufacturer		
4284A+42841A+42842C	Keysight Technologies		

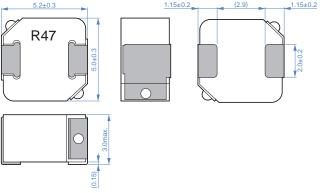
^{*} Equivalent measurement equipment may be used.

(2/4)



SPM5030-HZ type

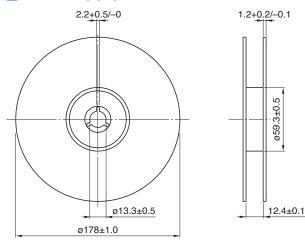
SHAPE & DIMENSIONS



Dimensions in mm

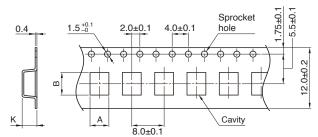
PACKAGING STYLE

REEL DIMENSIONS



Dimensions in mm

TAPE DIMENSIONS



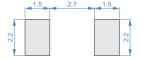
Dimensions in mm

Туре	Α	В	K
SPM5030-H7	5.3	5.5	3.3

PACKAGE QUANTITY

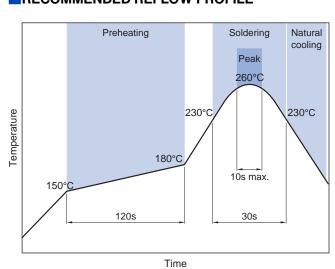
Package quantity	500 pcs/reel	

RECOMMENDED LAND PATTERN



Dimensions in mm

RECOMMENDED REFLOW PROFILE



■TEMPERATURE RANGE, INDIVIDUAL WEIGHT

Operating temperature range *	Storage temperature range **	Individual weight
-40 to +125 °C	-40 to +125 °C	0.38 g

^{*} Operating temperature range includes self-heating.

^{**} The storage temperature range is for after the assembly.



REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products

REMINDERS

The storage period is within 12 months. Be sure to follow the RH or less).	ne storage conditions (temperature: 5 to 40°C, humidity: 10 to 75%
If the storage period elapses, the soldering of the terminal	electrodes may deteriorate.
ODo not use or store in locations where there are conditions	such as gas corrosion (salt, acid, alkali, etc.).
Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature does not exceed 150°C.	perature difference between the solder temperature and chip
Soldering corrections after mounting should be within the r If overheated, a short circuit, performance deterioration, o	
OWhen embedding a printed circuit board where a chip is modue to the overall distortion of the printed circuit board and	bunted to a set, be sure that residual stress is not given to the chip d partial distortion such as at screw tightening portions.
Self heating (temperature increase) occurs when the powe thermal design.	r is turned ON, so the tolerance should be sufficient for the set
Ocarefully lay out the coil for the circuit board design of the A malfunction may occur due to magnetic interference.	non-magnetic shield type.
Ouse a wrist band to discharge static electricity in your body	through the grounding wire.
ODo not expose the products to magnets or magnetic fields.	
ODo not use for a purpose outside of the contents regulated	in the delivery specifications.
equipment, telecommunications equipment, home appliance equipment, office equipment, measurement equipment, incomplete the said automotive product is mounted in a vehicle automotive applications or standard applications as genera the scope and conditions described in this specification, who said product is intended to be used in the usual operation automotive products are not designed or warranted to meet performance and/or quality requires a more stringent level cause serious damage to society, person or property. Please understand that we are not responsible for any damage below or for any other use exceeding the range or conditions.	of safety or reliability, or whose failure, malfunction or defect could age or liability caused by use of the products in any of the applications as set forth in this specification sheet. below or if you have special requirements exceeding the range or
(1) Aerospace/aviation equipment(2) Transportation equipment (electric trains, ships, etc.)	(7) Transportation control equipment(8) Public information-processing equipment

- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment

- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

(4/4)